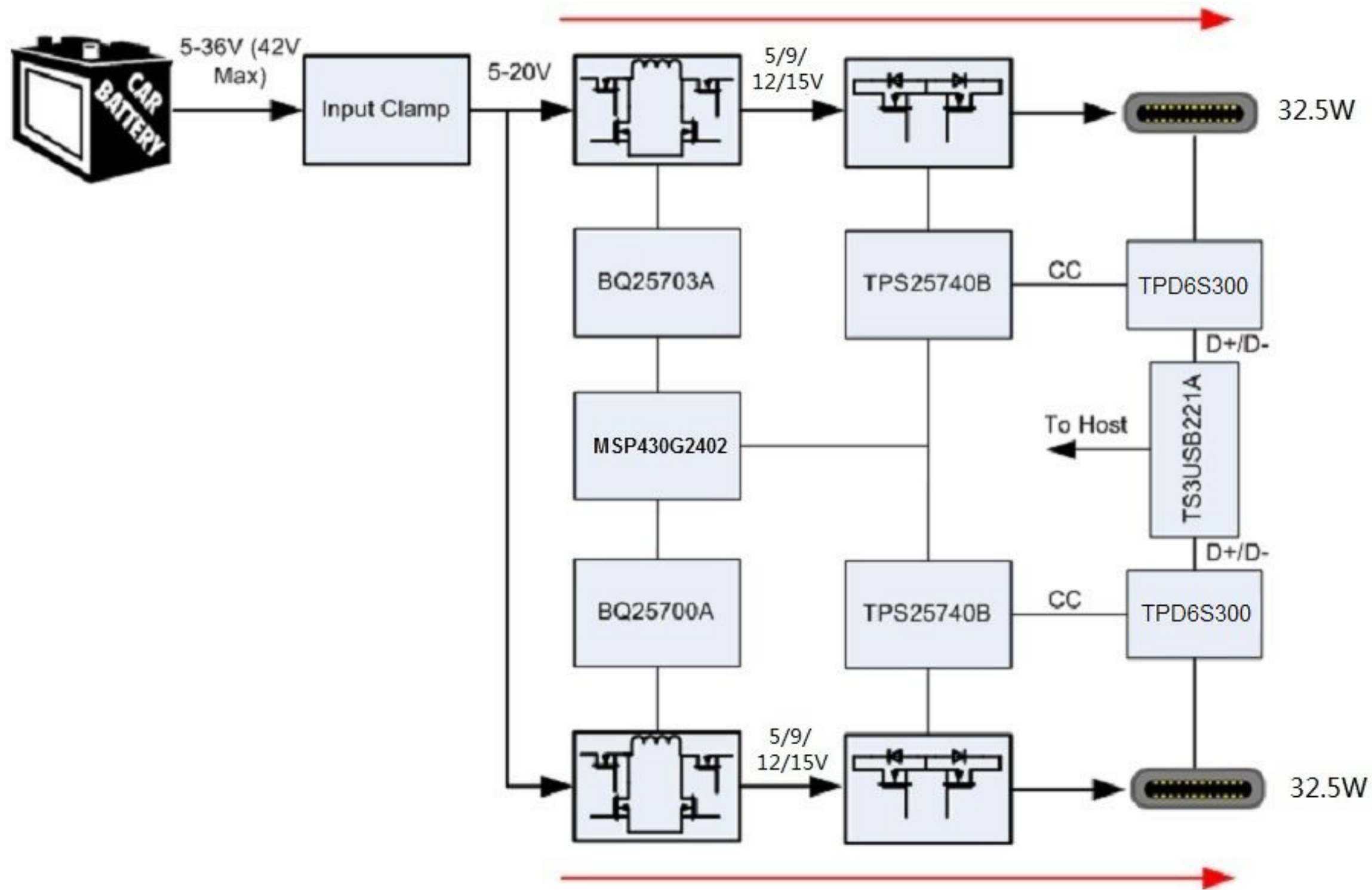


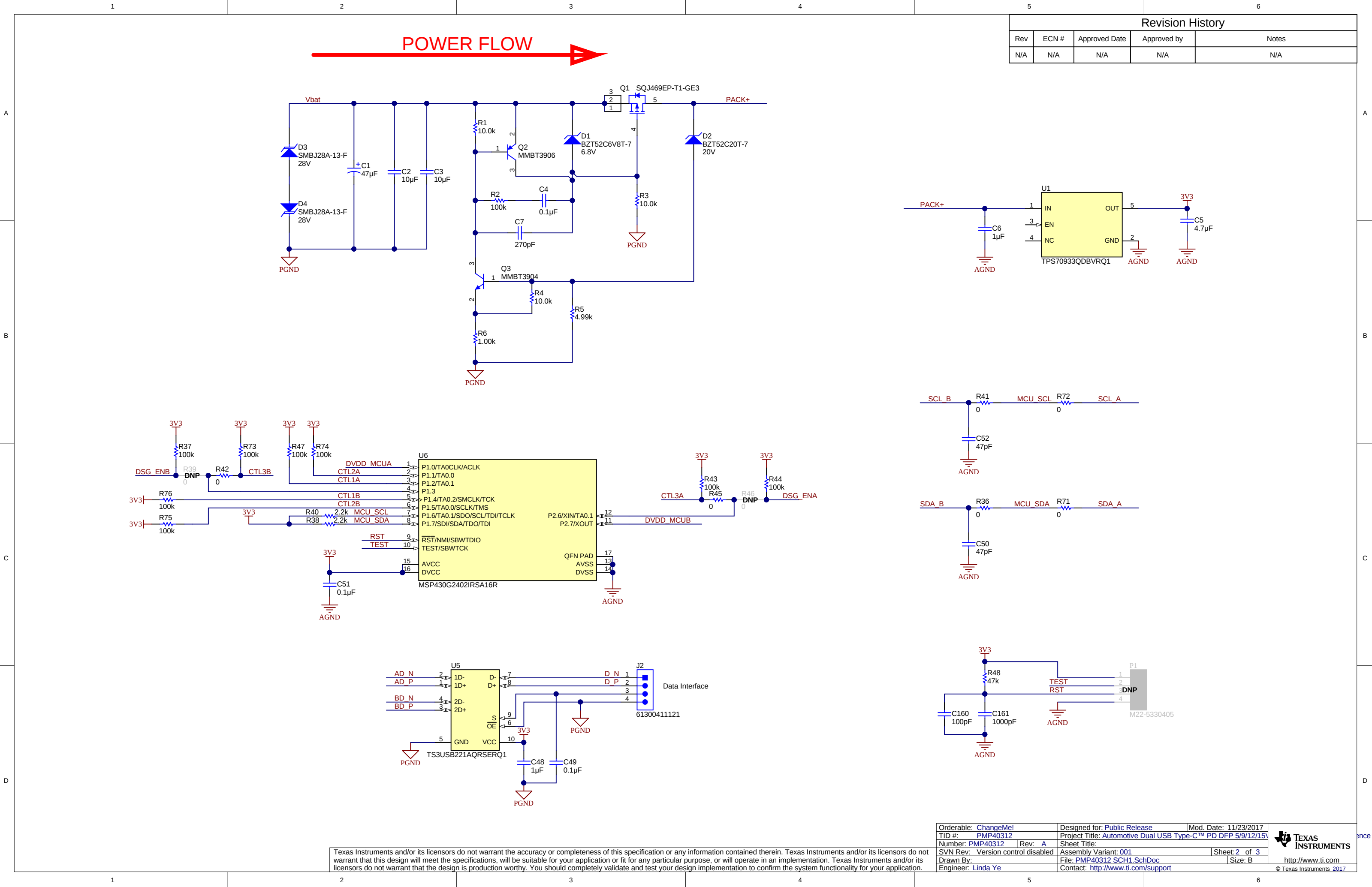
Revision History

Rev	ECN #	Approved Date	Approved by	Notes
N/A	N/A	N/A	N/A	N/A

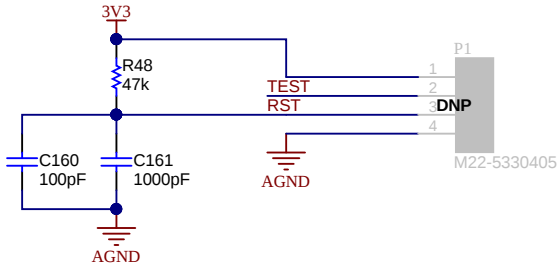
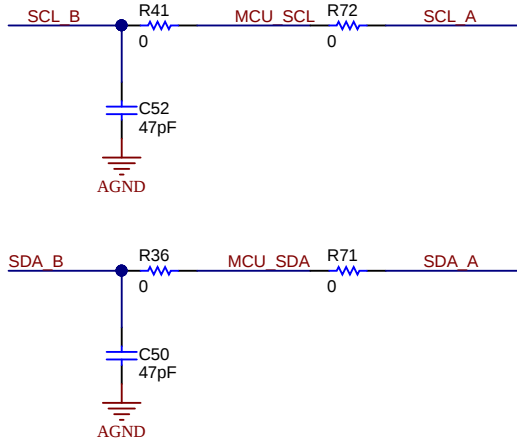
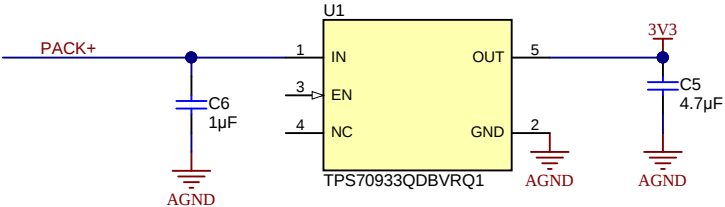


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Number: PMP40312	Rev: A	Assembly Variant: 001	
SVN Rev: Version control disabled	File: PMP40312 SCH BD.SchDoc	Size: B	
Drawn By: Linda Ye	Contact: http://www.ti.com/support		



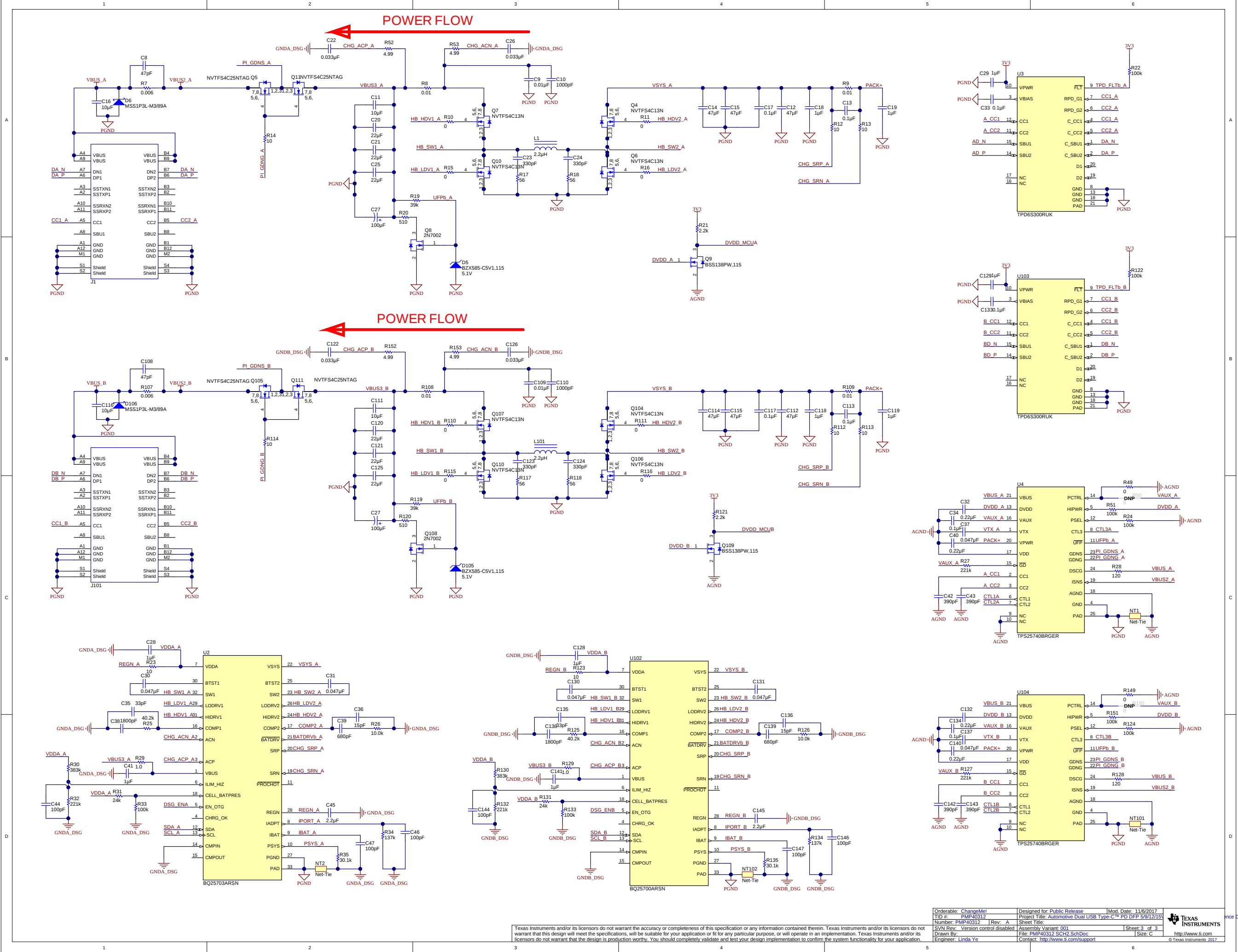
Revision History				
Rev	ECN #	Approved Date	Approved by	Notes
N/A	N/A	N/A	N/A	N/A



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Number: PMP40312	Rev: A	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 3
Drawn By: Linda Ye	File: PMP40312 SCH1.SchDoc	Size: B
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